

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	227577	257/\$.ccls. 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
2	BRS	L2	777	1 and (circuit adj pattern?)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
3	BRS	L3	1	2 and (inspect\$3 adj pattern?)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
4	BRS	L4	29	1 and measur\$3 near2 (line adj width)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
5	BRS	L6	1	5 and superimpos\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
6	BRS	L5	3	4 and (linear adj pattern)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
7	BRS	L7	167	suwa-Kyoichi.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
8	BRS	L9	1	8 and superimpos\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
9	BRS	L8	10	7 and (linear adj pattern)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
10	BRS	L10	0	8 and wegde-shaped	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
11	BRS	L11	3	8 and wedge-shaped	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
12	BRS	L12	51542	exposure.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
13	BRS	L13	54	12 and (linear adj pattern)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
14	BRS	L14	3	13 and wedge-shaped	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
15	BRS	L15	664	linear adj pattern?	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
16	BRS	L16	164	15 and exposure	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
17	BRS	L17	115	16 and (substrate or wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB
18	BRS	L18	8	17 and measur\$3 near2 (line adj width)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB